Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

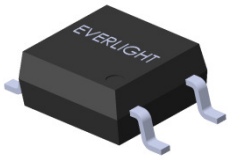
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

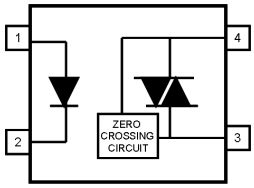
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

DATASHEET

4 PIN SOP ZERO-CROSS TRIAC PHOTOCOUPLER
ELM304X, ELM306X, ELM308X Series



Schematic



Pin Configuration
1. Anode
2. Cathode
3. Terminal
4. Terminal

Features:

- Peak breakdown voltage
  - 400V: ELM304X
  - 600V: ELM306X
  - 800V: ELM308X
- High isolation voltage between input and output (Viso=3750 V rms)
- Zero voltage crossing
- Pb free and RoHS compliant.
- UL approved (No. E214129)
- VDE approved (No.132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved

Description

The ELM304X, ELM306X and ELM308X devices consist of a GaAs infrared emitting diode optically coupled to a monolithic silicon detector performing the function of a zero voltage crossing bilateral triac driver.

They are designed for use with a discrete power triac in the interface of logic systems to equipment powered from 110 to 240 VAC lines, such as solid-state relays, industrial controls, motors, solenoids and consumer appliances, etc.

Applications

- Solenoid/valve controls
- Light controls
- Static power switch
- AC motor drivers
- E.M. contactors
- Temperature controls
- AC Motor starters
- Solid state relays

Absolute Maximum Ratings (Ta=25℃)

Parameter			Symbol	Rating	Unit
Input	Forward current		I_F	60	mA
	Peak forward current (1us pulse, 300pps)		$I_{F(PK)}$	1	A
	Reverse voltage		V_R	6	V
	Power Dissipation		P_D	100	mW
Output	Off-state Output Terminal Voltage	ELM304X	V_{DRM}	400	V
		ELM306X		600	
		ELM308X		800	
	On state RMS current		$I_{T(RMS)}$	70	mA(RMS)
	Power dissipation		P_C	300	mW
Isolation voltage *1			V_{ISO}	3750	Vrms
Operating temperature			T_{OPR}	-40~+110	℃
Storage temperature			T_{STG}	-55~+150	℃
Soldering Temperature*2			T_{SOL}	260	℃

Notes:

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

*2 For 10 seconds

Electro-Optical Characteristics (Ta=25℃ unless specified otherwise)

Input

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Forward Voltage	V_F	-	-	1.5	V	I_F = 30mA
Reverse Leakage current	I_R	-	-	10	μA	V_R = 6V

Output

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Peak Blocking Current	I_{DRM1}	-	-	100	nA	V_{DRM} = Rated V_{DRM} I_F = 0mA
Peak On-state Voltage	V_{TM}	-	-	3	V	I_{TM}=100mA peak
Critical Rate of Rise off-state Voltage	dv/dt	1000	-	-	V/μs	
Inhibit Voltage (MT1-MT2 voltage above which device will not trigger)	V_{INH}	-	-	20	V	I_F= Rated I_{FT}
Leakage in Inhibited State	I_{DRM2}	-	-	1000	μA	I_F= Rated I_{FT}, V_{DRM}=Rated V_{DRM}, off state

Transfer Characteristics

Parameter		Symbol	Min.	Typ.*	Max.	Unit	Condition
LED Trigger Current	3042 3062 3082	I_{FT}	-	-	10	mA	Main terminal Voltage=3V
	3043 3063 3083		-	-	5		
	3044 3064 3084		-	-	3		
Holding Current		I_H	-	280	-	μA	

* Typical values at T_a = 25℃

Typical Electro-Optical Characteristics Curves

Figure 1. Forward Current vs. Forward Voltage

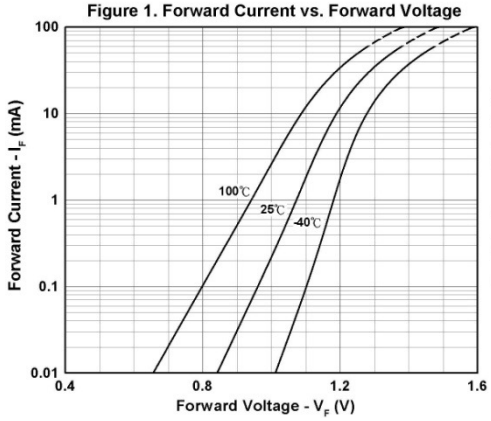


Figure 2. On-State Characteristics

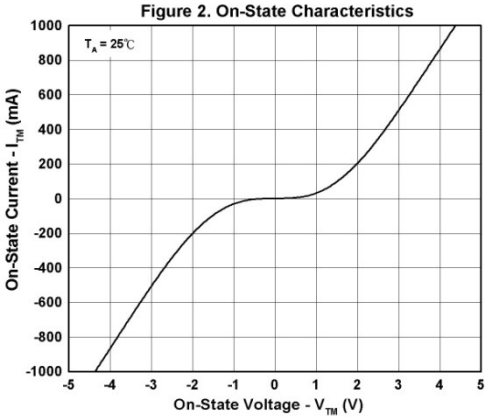


Figure 3. Holding Current vs. Ambient Temperature

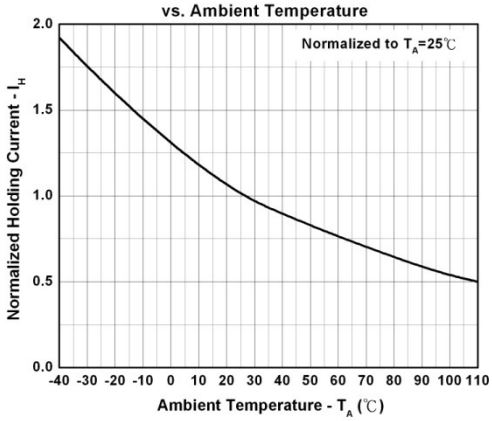


Figure 4. LED Current Required to Trigger vs. LED Pulse Width

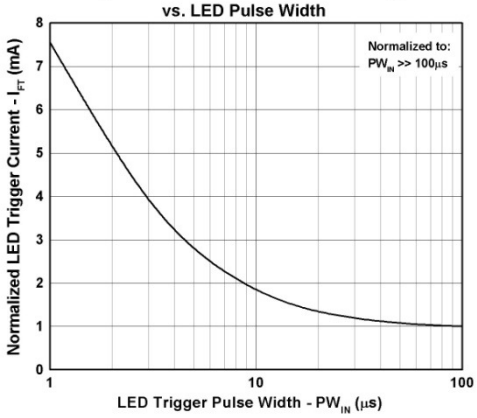


Figure 5. Leakage Current vs. Ambient Temperature

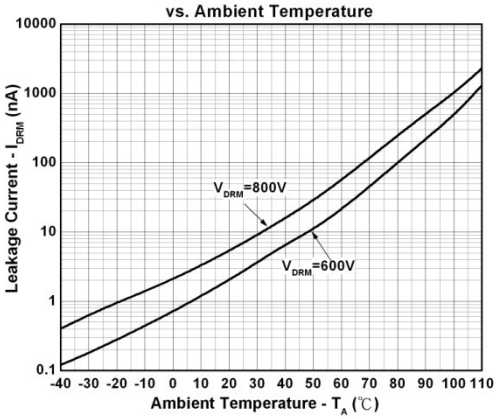


Figure 6. LED Trigger Current vs. Ambient Temperature

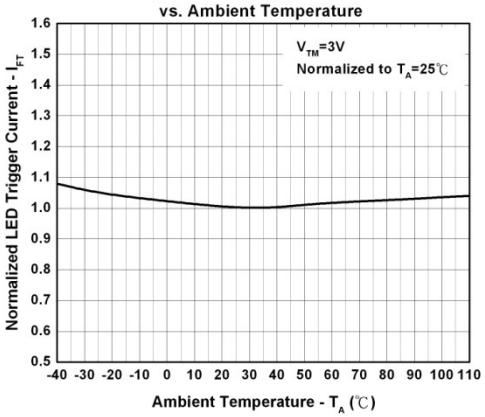


Figure 7. Off-State Output Terminal Voltage vs. Ambient Temperature

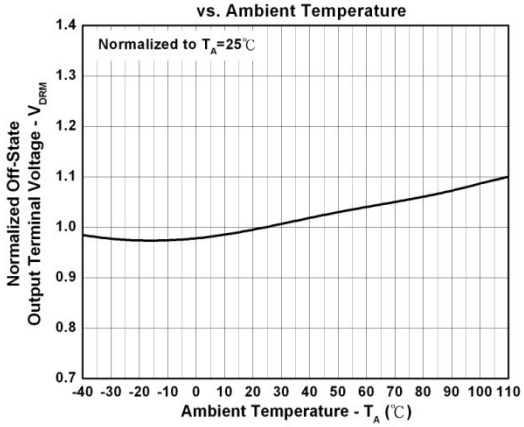


Figure 8. Leakage in Inhibit State vs. Ambient Temperature

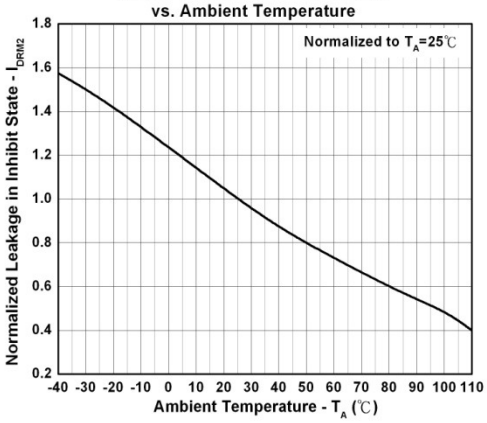


Figure 9. Inhibit Voltage vs. Ambient Temperature

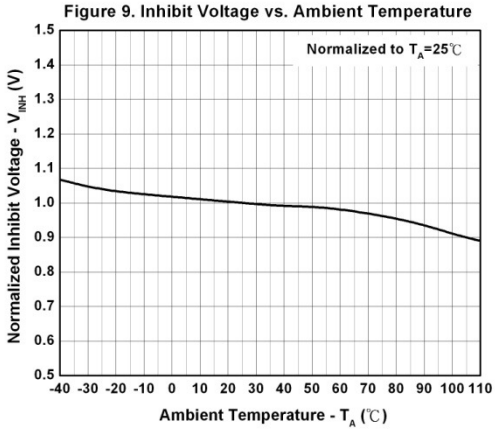
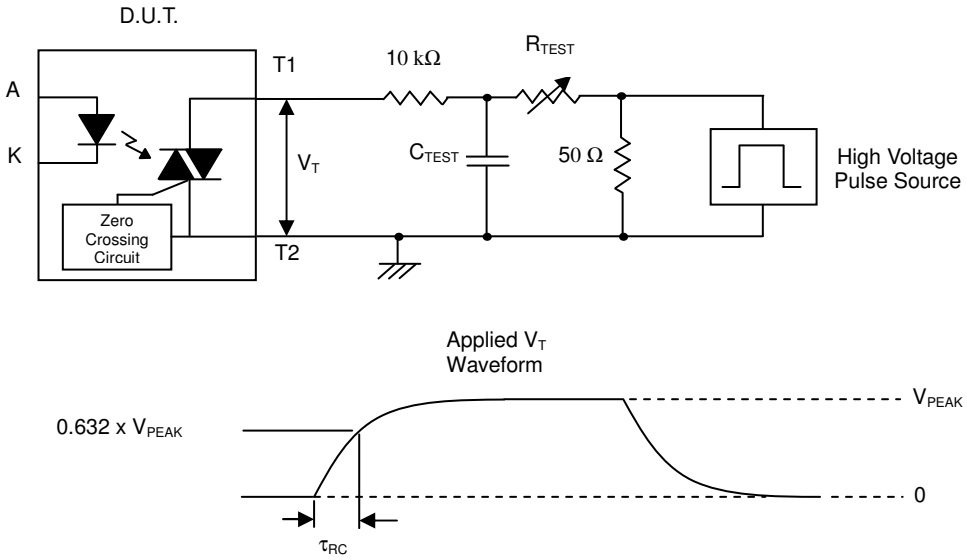


Figure 10. Static dv/dt Test Circuit & Waveform



Measurement Method

The high voltage pulse is set to the required V_{PEAK} value and applied to the D.U.T. output side through the RC circuit above. LED current is not applied. The waveform V_T is monitored using a x100 scope probe. By varying R_{TEST}, the dv/dt (slope) is increased, until the D.U.T. is observed to trigger (waveform collapses). The dv/dt is then decreased until the D.U.T. stops triggering. At this point, τ_{RC} is recorded and the dv/dt calculated.

$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$$

$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$$

For example, V_{PEAK} = 600V for EL306X series. The dv/dt value is calculated as follows:

$$dv/dt = \frac{0.63 \times 600}{\tau_{RC}} = \frac{378}{\tau_{RC}}$$

Order Information

Part Number

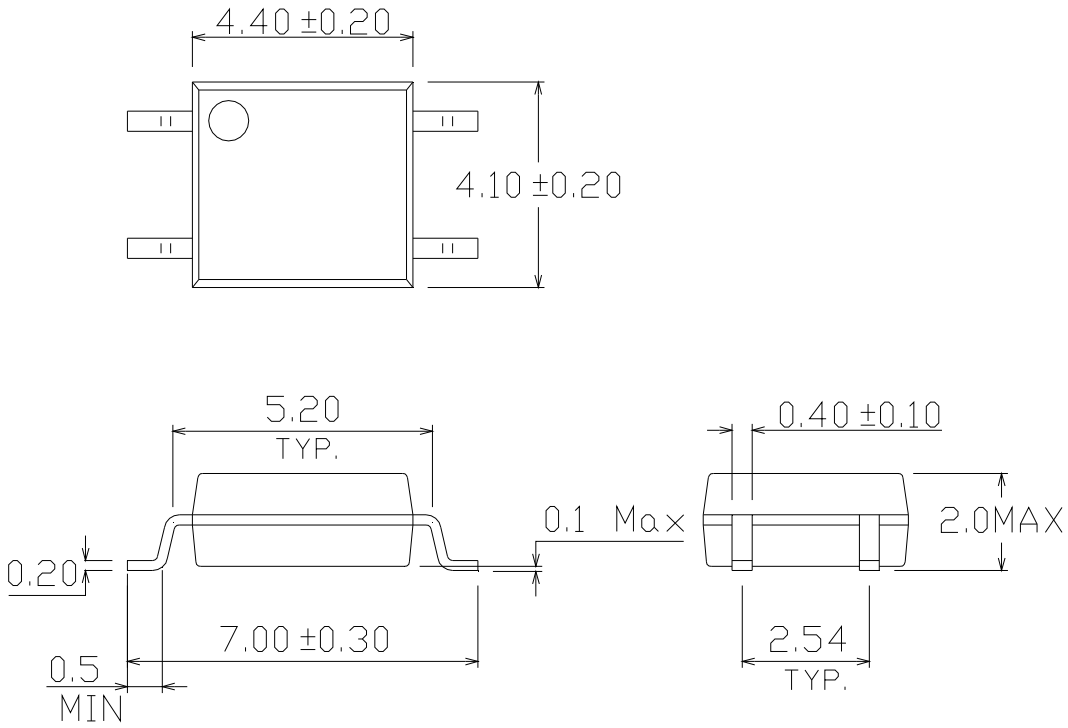
ELM304X(Z)-V
or ELM306X(Z)-V
or ELM308X(Z)-V

Note

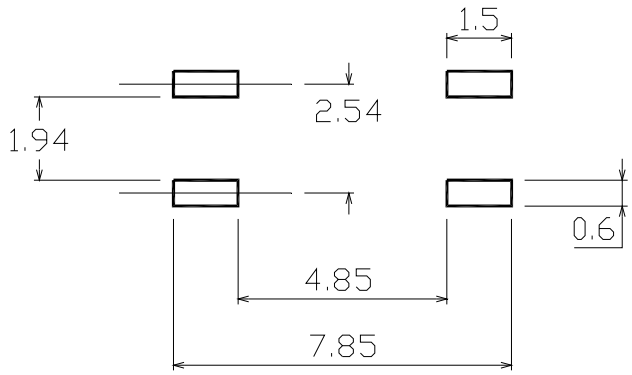
X = Part No. (2 for I_{FT}=10mA, 3 for I_{FT}=5mA, 4 for I_{FT}=3mA)
Z = Tape and reel option (TA, TB or none).
V = VDE safety approved optional

Option	Description	Packing quantity
None	Standard	100 units per tube
None	Standard + VDE safety optional	100 units per tube
(TA)	TA tape & reel option	3000 units per reel
(TB)	TB tape & reel option	3000 units per reel
(TA)-V	TA tape & reel option + VDE safety optional	3000 units per reel
(TB)-V	TB tape & reel option + VDE safety optional	3000 units per reel

Package Dimension (Dimensions in mm)



Recommended pad layout for surface mount leadform



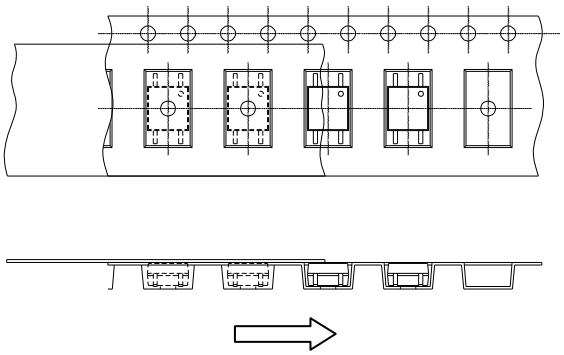
Device Marking

Notes

EL	denotes Everlight
M3063	denotes Device Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE safety option (optional)

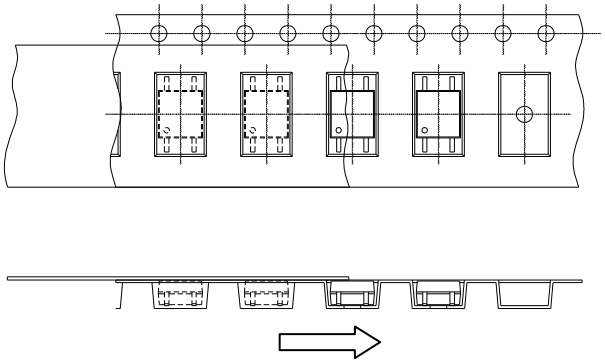
Tape & Reel Packing Specifications

Option TA



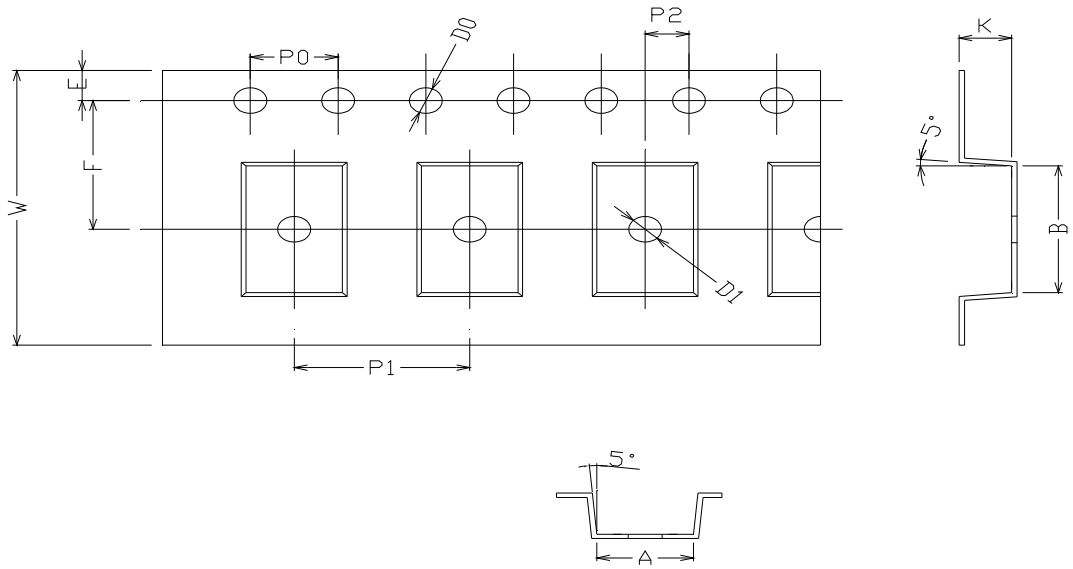
Direction of feed from reel

Option TB



Direction of feed from reel

Tape dimensions



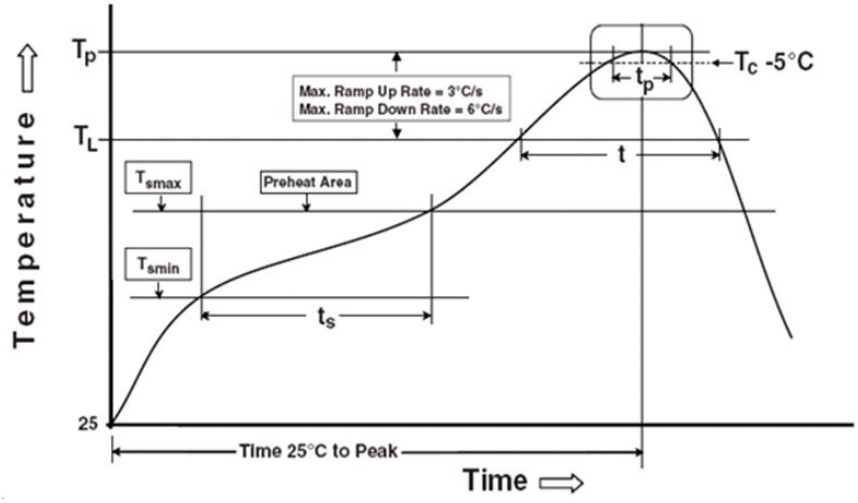
Dimension No.	A	B	Do	D1	E	F
Dimension (mm)	4.4 ± 0.1	7.4 ± 0.1	1.5 + 0.1/-0	1.5 ± 0.1	1.7 5± 0.1	7.5 ± 0.1

Dimension No.	Po	P1	P2	t	W	K
Dimension (mm)	4.0 ± 0.15	8.0 ± 0.1	2.0 ± 0.1	0.25 ± 0.03	16.0 ± 0.2	2.4 ± 0.1

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note: Reference: IPC/JEDEC J-STD-020D

Preheat	
Temperature min (T_{smin})	150 ℃
Temperature max (T_{smax})	200℃
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 ℃/second max
Other	
Liquidus Temperature (T_L)	217 ℃
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_P)	260℃
Time within 5 ℃ of Actual Peak Temperature: T_P - 5℃	30 s
Ramp- Down Rate from Peak Temperature	6℃ /second max.
Time 25℃ to peak temperature	8 minutes max.
Reflow times	3 times

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DISCLAIMER

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